

## P-Channel 20-V (D-S) MOSFET

#### **Features**

- Low rDS(on) trench technology
- Low thermal impedance
- Fast switching speed
- RoHS compliant package

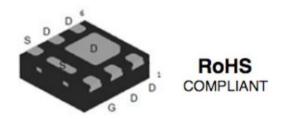
### **Typical Applications:**

- Load Switches
- Motor Drives
- DC/DC Conversion

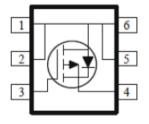
Package type: DFN2X2

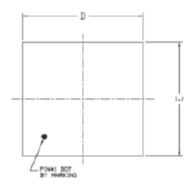
### **Packing & Order Information**

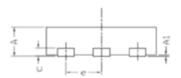
3,000/Reel

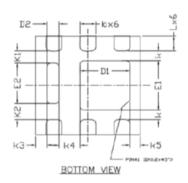


#### Graphic symbol









	Symbol	Dimens	ions in Millimeters		Dimensions in Inches		nches	
		MIN	NOM	MAX	MIN	NOM	MAX	
	Α	0.50	0.55	0.60	0.02	0.022	0.024	
	A1	0.00	-	0.05	0.00	1	0.002	
	b	0.25	0.30	0.35	0.01	0.012	0.014	
	Е		0.152 BEF	=	0.006 BEF			
	D	1.90	2.00	2.10	0.750	0.079	0.083	
	D1	0.85	0.95	1.05	0.033	0.037	0.041	
	D2	0.13	0.23	0.33	0.005	0.009	0.013	
	E	1.90	2.00	2.10	0.075	0.079	0.083	
	E1	0.90	1.00	1.10	0.035	0.039	0.043	
	E2	0.72	0.82	0.92	0.028	0.032	0.036	
	е	0.65 BSC 0.20 BSC 0.25 BSC 0.33 BSC 0.22 BSC 0.40 BSC 0.20 BSC			0.026 BSC			
	K				0.008 BSC			
	K1				0.010 BSC			
	K2				0.013 BSC			
	K3				0.009 BSC			
	K4				0.016 BSC			
	K5				0.008 BSC			
	L	0.25	0.30	0.35	0.010 0.012 0.014			



# P-Channel 20-V (D-S) MOSFET

Absolute Maximum Ratings (T <sub>A</sub> =25°C unless otherwise specified)					
Symbol	Parameter	Value	Unit		
$V_{\rm DS}$	Drain-Source Voltage	-20	V		
V <sub>GS</sub>	Gate-Source Voltage	±8	V		
т	Continuous Drain Current <sup>a</sup> (T <sub>A</sub> =25°C)	-8.8	A		
$I_D$	Continuous Drain Current <sup>a</sup> (T <sub>A</sub> =70°C)	-7	A		
$I_{DM}$	Pulsed Drain Current <sup>b</sup>	-40	A		
Is	Continuous Source Current (Diode Conduction) <sup>a</sup>	-5	A		
D	Power Dissipation <sup>a</sup> (T <sub>A</sub> =25°C)	3	W		
$P_D$	Power Dissipation <sup>a</sup> (T <sub>A</sub> =70°C)	1.9	W		
T <sub>J</sub> /T <sub>STG</sub>	Operating Junction and Storage Temperature	-55 to 150	°C		

Thermal Resistance Ratings						
Symbol	Parameter	Maximum	Units			
Des	Maximum Junction-to-Ambient <sup>a</sup> (t <= 10 sec)	40	°C/W			
RөлА	Maximum Junction-to-Ambient <sup>a</sup> (Steady-State)	90	C/W			

#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

Static						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS}=V_{GS},I_D\!=\text{-250}\mu\text{A}$	-0.4			V
Igss	Gate-Body Leakage	$V_{DS} = 0 V$ , $V_{GS} = \pm 8 V$			±100	nA
IDSS	Zero Gate Voltage Drain Current	$\begin{aligned} V_{DS} &= -16 \ V \ , \ V_{GS} = 0 \ V \\ V_{DS} &= -16 \ V \ , \ V_{GS} = 0 \ V \ , \ T_{J} = 55 ^{\circ} C \end{aligned}$			-1 -25	uA
I <sub>D(on)</sub>	On-State Drain Current	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-12			A
rDS (on)	Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -7 \text{ A}$ $V_{GS} = -2.5 \text{ V}, I_D = -5.6 \text{ A}$			26 34	mΩ
gfs	Forward Tranconductance	$V_{GS} = -15 \text{ V}, I_D = -7 \text{ A}$		8		S
V <sub>SD</sub>	Diode Forward Voltage	$I_S = -2.5 A$ , $V_{GS} = 0 V$		-0.68		V



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Dynamic b						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$Q_g$	Total Gate Charge	$V_{DS} = -10 \text{ V}, I_{D} = -7 \text{ A},$ $V_{GS} = -4.5 \text{ V}$		30		nC
$Q_{gs}$	Gate-Source Charge			4		nC
$Q_{\mathrm{gd}}$	Gate-Drain Charge			6		nC
$t_{d(on)}$	Turn-On Delay Time	$I_{D} = -7 \text{ A}, R_{L} = 1.4 \Omega,$ $V_{GEN} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$ $V_{DS} = -10 \text{ V}$		6		ns
$t_{\rm r}$	Rise Time			12		ns
$t_{d(off)}$	Turn-Off Delay Time			85		ns
tf	Fall Time			35		ns
C <sub>ISS</sub>	Input Capacitance	$V_{DS} = -15 \text{ V}$ $f = 1 \text{ MHz }, V_{GS} = 0 \text{ V}$		1435		pF
Coss	Output Capacitance			126		pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			113		pF

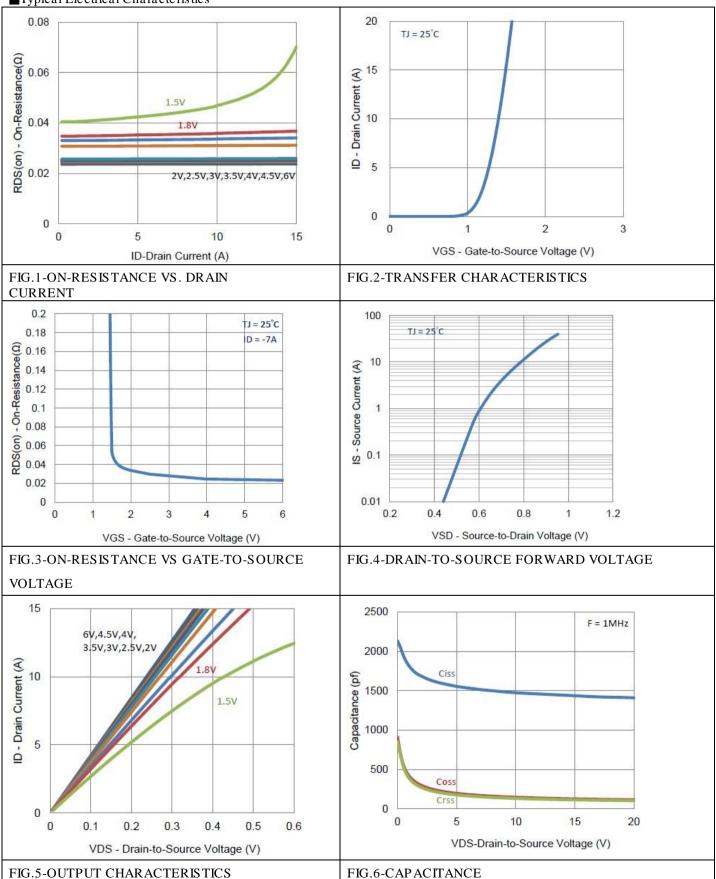
#### Notes

- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.



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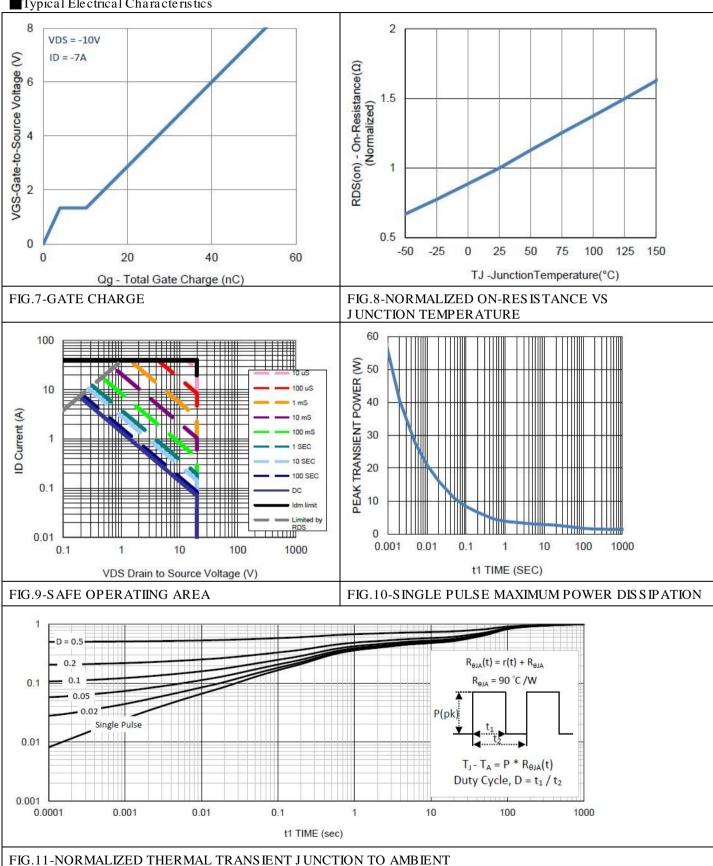






### P-Channel 20-V (D-S) MOSFET

#### ■Typical Electrical Characteristics





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